

Docket No.: 52352-483



#10/B 9/11/02
9)
PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Raj MASTER, et al.

Application No.: 09/922,936

Filed: August 7, 2001

Group Art Unit: 1725

Examiner: Z. Pittman

For: CONTROLLED AND PROGRAMMED DEPOSITION OF FLUX ON A FLIP-CHIP BY
SPRAYING

AMENDMENT

Box Non-Fee Amendment
The Commissioner for Patents and Trademarks
Washington, DC 20231

Sir:

The following Amendment and Remarks are submitted in response to the Office Action dated June 7, 2002. Please amend the above-identified application as follows:

IN THE SPECIFICATION:

Please amend the specification as follows:

Page 6, third paragraph, please delete in its entirety and replace with the following:

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--Fig. 2B depicts a rear view of the flux dispenser 22 shown in Fig. 2A. As depicted, the flux dispenser 22 is further equipped with a main air pressure supply 29, which maintains the main pressure of the flux dispenser 22 at a pressure range between about 60 psi and about 100 psi, thereby maintaining the fluid pressure and the valve pressure at the prescribed pressure ranges. A power supply line 27 and an interface port 28 are also provided to the flux dispenser 22. Particularly, the interface port 28 is provided for exchanging flux dispensing control data